

Statement of Compliance

Requested Part

02 October 2015

2-1393231-8

(Part 1 of 1)

RP418024

Part Status:	Active
Mil-Spec Certified:	No
EU RoHS/ELV Code:	Converted to EU RoHS but not ELV Compliant
Solder Process Capability Code:	Wave solder capable to 265°C
China RoHS:	Restricted Materials Above Threshold
	•
Exemptions:	8(b) - Cd-Electrical Contacts
REACH Oct 2008 SvHC Compliance:	Contains no REACH October 2008 SvHC(s)
REACH Jan/Mar 2010 SvHC Compliance:	Contains no REACH Jan/Mar 2010 SvHC(s)
REACH June 2010 SvHC Compliance:	Contains no REACH June 2010 SvHC(s)
REACH December 2010 SvHC Compliance:	Contains no REACH December 2010 SvHC(s)
REACH June 2011 SvHC Compliance:	Contains no REACH June 2011 SvHC(s)

Contains no REACH December 2011 SvHC(s) REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Contains no REACH June 2012 SvHC(s) REACH December 2012 SvHC Compliance: Contains no REACH December 2012 SvHC(s) REACH June 2013 SvHC Compliance: Contains REACH June 2013 SvHC(s) SvHC 1: Cadmium oxide @ 0.10 % wt REACH December 2013 SvHC Compliance: Contains no REACH December 2013 SvHC(s) REACH June 2014 SvHC Compliance: Contains no REACH June 2014 SvHC(s) REACH December 2014 SvHC Compliance: Contains no REACH December 2014 SvHC(s) REACH June 2015 SvHC Compliance: Not Reviewed for REACH June 2015 SvHC(s)

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

Finished electrical and electronic products will be CE marked as required by Directive 2011/65/EU (RoHS2). Components may not be CE marked.

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



REACH Substance Communication Document: Halogen Content:

Download

Not Low Halogen - contains Br or Cl > 900 ppm.



Guy Degrieck Manager, Product Environmental Compliance

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中国电子电气产品中有害物质的名称及含量

China EEP Hazardous Substance Information

TOE X
+/ar

Restricted Materials Above Threshold

部件名称 (Component Name) 2-1393231-8	有害物质 Hazardous Substance							
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)		
继电 (Rela		0	0	х	Ο	0	0	
本表格	依据SJ/T 1136	34标准的规定编	制。	This table is	compiled acc	cording to SJ/T	11364 standar	
Indic	ates that the o	该部件所有均质 concentration o threshold of th	f the hazardou	is substance in				
Indic	ates that the o	少在该部件的某 concentration o elevant thresho	f the hazardou	is substance in	n at least one			
	a	子电气产品的现	下保使用期限依	据SJ/T 11388	标准的规定确	定。		
		5 — 1 7 AA.10			11 · E			

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